

Analog Devices Welcomes Hittite Microwave Corporation

NO CONTENT ON THE ATTACHED DOCUMENT HAS CHANGED



THIS PAGE INTENTIONALLY LEFT BLANK



Typical Applications

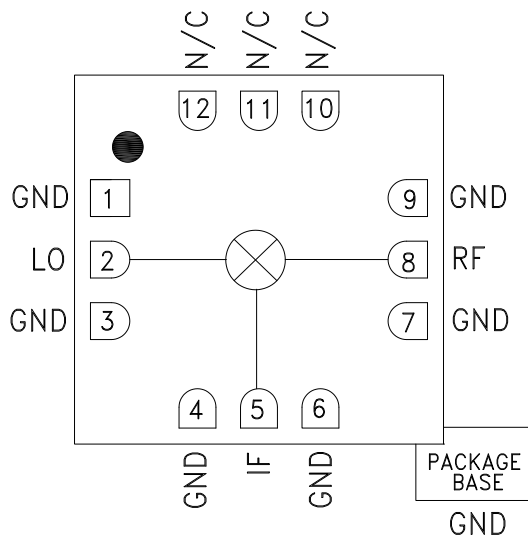
The HMC558LC3B is ideal for:

- Point-to-Point Radios
- Point-to-Multi-Point Radios
- Test Equipment & Sensors
- Military End-Use

Features

- Passive Double Balanced Topology
- High LO/RF Isolation: 45 dB
- Low Conversion Loss: 7 dB
- Wide IF Bandwidth: DC - 6 GHz
- 12 Lead Ceramic 3x3mm SMT Package: 9mm²

Functional Diagram



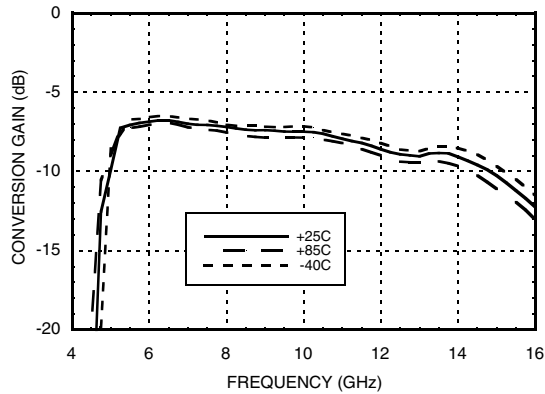
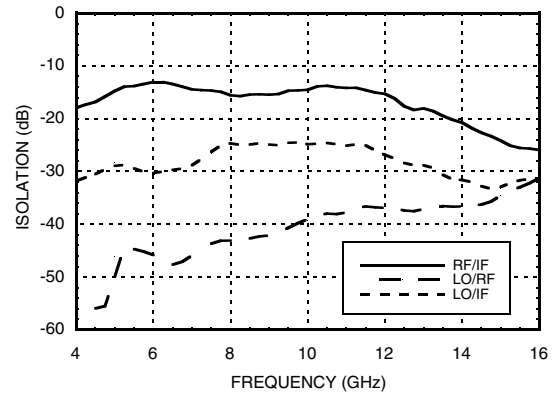
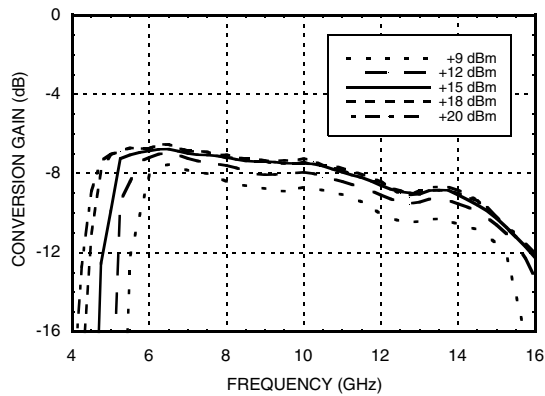
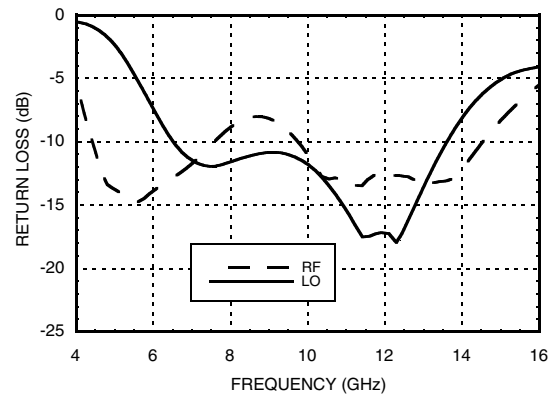
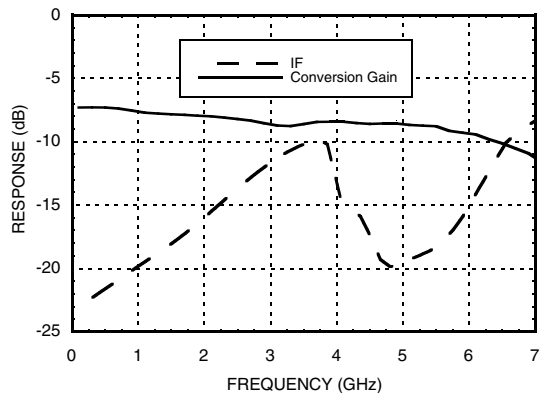
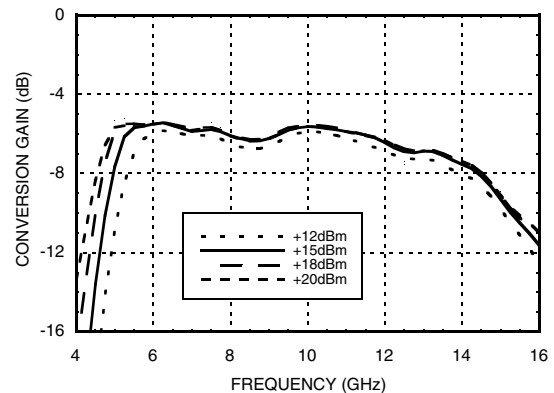
General Description

The HMC558LC3B is a general purpose double balanced mixer in a leadless RoHS compliant SMT package that can be used as an upconverter or downconverter between 5.5 and 14 GHz. This mixer is fabricated in a GaAs MESFET process, and requires no external components or matching circuitry. The HMC558LC3B provides excellent LO to RF and LO to IF isolation due to optimized balun structures and operates with LO drive levels as low as +9 dBm. The RoHS compliant HMC558LC3B eliminates the need for wire bonding, and is compatible with high volume surface mount manufacturing techniques.

Electrical Specifications, $T_A = +25^\circ C$, $IF = 100 MHz$, $LO = +15 dBm^*$

Parameter	Min.	Typ.	Max.	Min.	Typ.	Max.	Units
Frequency Range, RF & LO	5.5 - 10.0		10.0 - 14.0				GHz
Frequency Range, IF	DC - 6		DC - 6				GHz
Conversion Loss		7	9.5		8.5	10	dB
Noise Figure (SSB)		7	9.5		8.5	10	dB
LO to RF Isolation	35	45		30	36		dB
LO to IF Isolation	20	25		20	25		dB
RF to IF Isolation	8	14		10	16		dB
IP3 (Input)		20			24		dBm
IP2 (Input)		54			46		dBm
1 dB Gain Compression (Input)		11			13		dBm

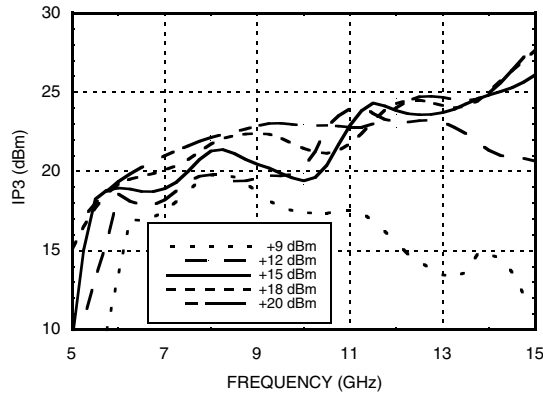
*Unless otherwise noted, all measurements performed as downconverter, $IF = 100 MHz$.


**GaAs MMIC FUNDAMENTAL
MIXER, 5.5 - 14.0 GHz**
**Conversion Gain vs. Temperature
@ LO = +15 dBm**

Isolation @ LO = +15 dBm

Conversion Gain vs. LO Drive

Return Loss @ LO = +15 dBm

IF Bandwidth @ LO = +15 dBm

**Upconverter Performance
Conversion Gain vs. LO Drive**


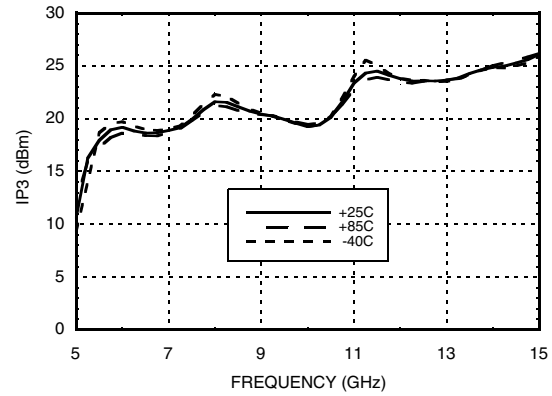


GaAs MMIC FUNDAMENTAL MIXER, 5.5 - 14.0 GHz

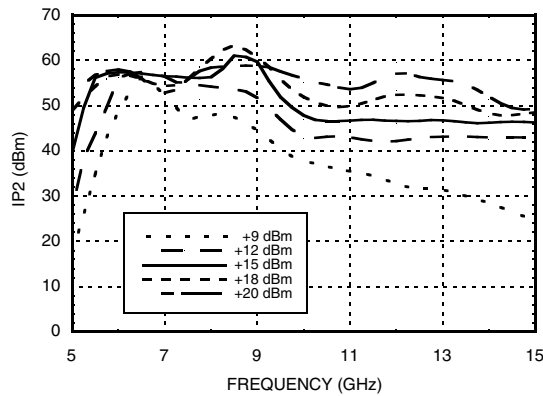
Input IP3 vs. LO Drive *



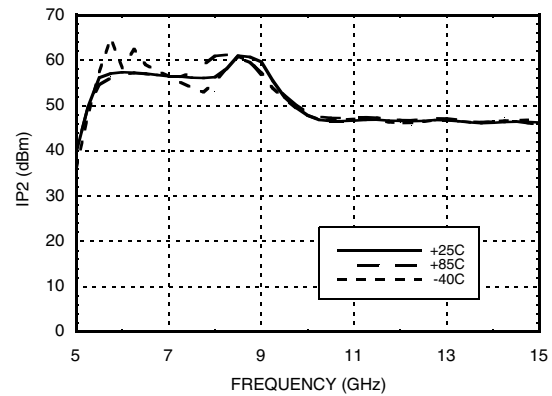
Input IP3 vs. Temperature @ LO = +15 dBm *



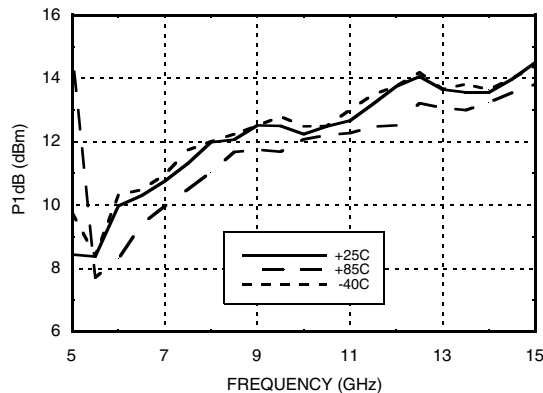
Input IP2 vs. LO Drive *



Input IP2 vs. Temperature @ LO = +15 dBm *



Input P1dB vs. Temperature @ LO = +15 dBm



MxN Spurious Outputs

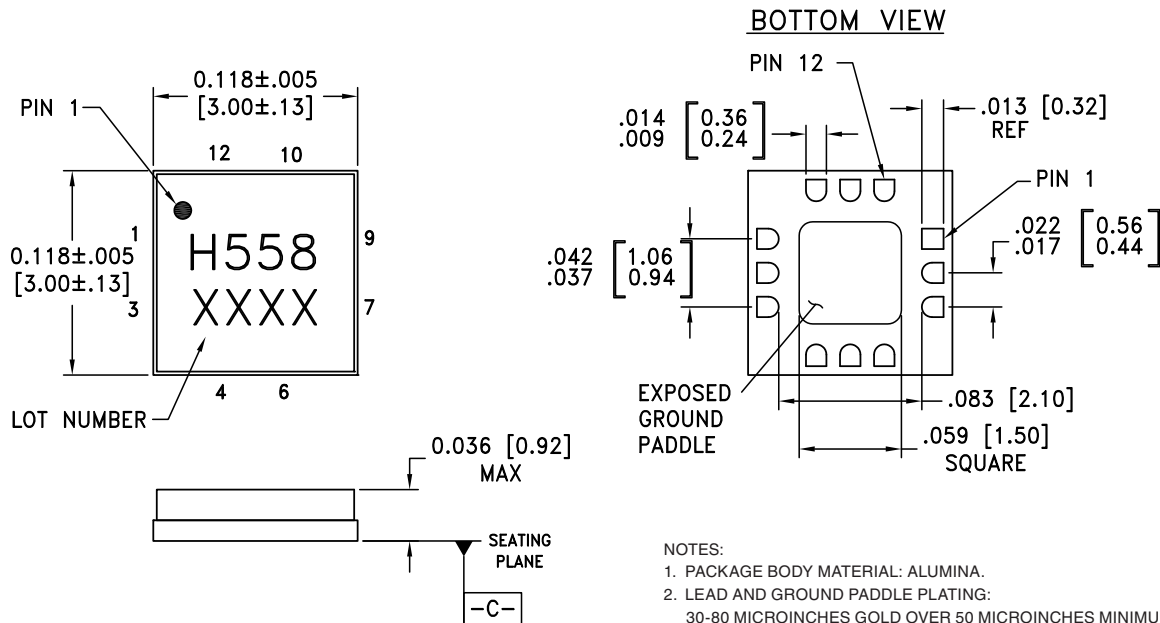
mRF	nLO				
	0	1	2	3	4
0	xx	-6	22	17	33
1	10	0	25	49	51
2	78	50	82	51	74
3	78	78	75	75	78
4	78	78	78	78	78

RF = 8.1 GHz @ -10 dBm
 LO = 8 GHz @ +15 dBm
 All values in dBc below the IF output power level.

* Two-tone input power = -10 dBm each tone, 1 MHz spacing.

Absolute Maximum Ratings

RF / IF Input	+25 dBm
LO Drive	+25 dBm
Channel Temperature	150 °C
Continuous P _{diss} (T = 85 °C) (derate 3.25 mW/°C above 85 °C)	211 mW
Thermal Resistance (channel to ground paddle)	307 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C


**ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS**
Outline Drawing

Package Information


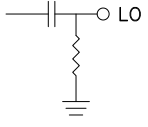
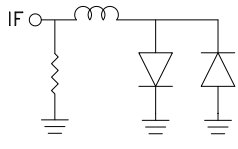
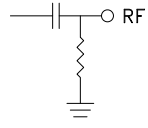
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[2]
HMC558LC3B	Alumina, White	Gold over Nickel	MSL3 ^[1]	H558 XXXX

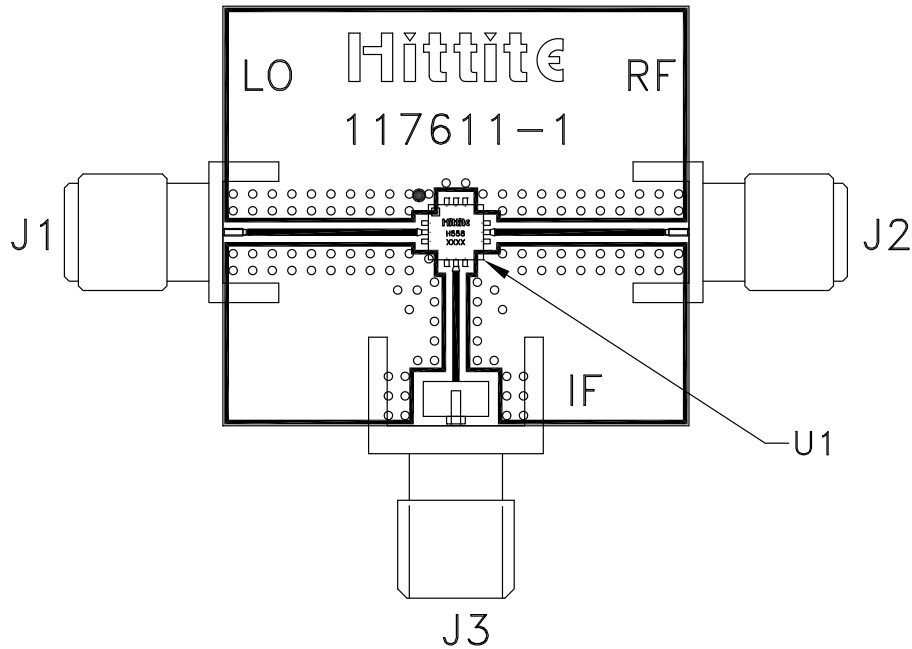
[1] Max peak reflow temperature of 260 °C

[2] 4-Digit lot number XXXX



Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 3, 4, 6, 7, 9	GND	Package bottom must also be connected to RF/DC ground.	
2	LO	This pin is DC coupled and matched to 50 Ohms.	
5	IF	This pin is DC coupled. For applications not requiring operation to DC, this port should be DC blocked externally using a series capacitor whose value has been chosen to pass the necessary IF frequency range. For operation to DC, this pin must not source or sink more than 2 mA of current or part non-function and possible part failure will result.	
8	RF	This pin is DC coupled and matched to 50 Ohms.	
10, 11, 12	N/C	No connection required. These pins may be connected to RF/DC ground without affecting performance.	

Evaluation PCB

List of Materials for Evaluation PCB 109952 [1]

Item	Description
J1 - J2	SRI SMA Connector
J3	Johnson SMA Connector
U1	HMC558LC3B Mixer
PCB [2]	117611 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Arlon 25 RF

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.